ABSOCIATION CONNECTING ELECTROMICS INDUSTRIES® International and P	IPC, Bannock	burn, Illinois. A	ll rights reserved u ntions.	nder both	This docume level parts, t	ent is a decla the declaratio	ration con	of the substar mpasses all l	nces wit ower le	hin the manufac vel materials for	turer listed i which the n	tem. No nanufac	ote: if the	e item is an as s engineering	sembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribut				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mate					erials and M	ials and Mfg Information				
Supplier Information															
Company name*	Company unique ID			Unique ID Authority					Respon	Response Date*					
nsemi										2024-05-18					
Contact Name	Title - Conta	Title - Contact			Phone - Contact*					Email -	Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance				NA					Produc	Product-Env-Stewards@onsemi.com				
uthorized Representative*	Title - Repres	Title - Representative			Phone - Representative*				Email -	Email - Representative*					
Product-Env-Stewards	Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Iter	n Number	ber Mfr Item Name MLP 30V 4.8A 40O DUAL NCH			Effective D	Effective Date Version Manufacturing Sit		ufacturing Site		Weight*		UOM	Unit Type	
	FDMB3	800N			Н	2024-05-18 TH2			13.39663		63	mg	Each		
Ianufacturing Proccess Inform	ation													1	I
Terminal Plating / Grid Array N	/aterial '	Terminal Base	Alloy	J-STD-020 MSL Rati		Peak Process Body		Body Tempe	Temperature Max Time at Peak		ak Tempera	Temperature Number		of Reflow Cyc	les
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		С		30		ids 3	}		
omments															
vel 1 - maximum time at peak tempera	ture during so	ldering is 10-3	0 seconds												
or more information regarding materia	al composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material Weight U		Unit of Measure	Level Substance		CAS	Exempt	Weight	Unit of Measure
Die	0.9624	mg	Supplier	Silicon (Si)	7440-21-3		0.9624	mg
Die Attach	0.13803	mg	Supplier	Bis(a,a-dimethylbenzyl) Peroxide	80-43-3		0.0007	mg
			Supplier	Isobornyl Methacrylate	7534-94-3		0.0076	mg
			Supplier	Silver (Ag)	7440-22-4		0.1145	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.0076	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.0076	mg
Lead Frame	5.6124	mg	Supplier	Zinc (Zn)	7440-66-6		0.007	mg
			Supplier	Iron (Fe)	7439-89-6		0.1319	mg
			Supplier	Copper (Cu)	7440-50-8		5.4689	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0046	mg
Mold Compound-Black	6.533	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.3594	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0131	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.9193	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.9146	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.3266	mg
Plating	0.0784	mg	Supplier	Silver (Ag)	7440-22-4		0.0012	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0028	mg
			В	Nickel (Ni)	7440-02-0		0.0728	mg
			Supplier	Gold (Au)	7440-57-5		0.0016	mg
Wire Bond - Au	0.0724	mg	Supplier	Gold (Au)	7440-57-5		0.0724	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).